



RAYSTAR

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曜凌光電股份有限公司



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RFE430W-AWH-DNN

SPECIFICATION

CUSTOMER:

APPROVED BY	
PCB VERSION	
DATE	

FOR CUSTOMER USE ONLY

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

Release DATE:

TFT Display Inspection Specification: <https://www.raystar-optronics.com/download/products.htm>

Precaution in use of TFT module: <https://www.raystar-optronics.com/download/declaration.htm>

Revision History

VERSION	DATE	REVISED PAGE NO.	Note
0	2019/08/27		First issue
A	2020/10/30		Modify AC Characteristics and Interface
B	2021/02/10		Modify Interface
C	2021/07/22		Update IC Rev.

Contents

1.Module Classification Information

2.Summary

3.General Specification

4.Interface

5.Contour Drawing

6.Block Diagram

7.Absolute Maximum Ratings

8.Electrical Characteristics

9.AC Characteristics

10.Power sequence

11.Optical Characteristics

12.Reliability

13.Other

1.Module Classification Information

R	F	E	43	0W	-	A	W	H	-	D	N	N
1	2	3	4	5	-	6	7	8	-	9	10	11

Item	Description	
1	R : Raystar Optronics Inc.	
2	Display Type : F→TFT Type, J→ Custom TFT	
3	Solution: A: 128x160 B:320x234 C:320x240 D:480x234 E:480x272 F:800x480 G:640x480 H:1024x600 I:320x480 J:240x320 K:1280x800 L:240x400 M:1024x768 N:128x128 O:480x800 P:640x320 Q:800x600 S:480x128 T:800x320	
4	Display Size : 4.3" TFT	
5	Version Code.	
6	Model Type: A : TFT LCD E : TFT+FR+CONTROL BOARD J : TFT+FR+A/D BOARD N : TFT+FR+A/D BOARD+CONTROL BOARD S : TFT+FR+POWER BOARD (DC TO DC) 1 : TFT+CONTROL BOARD	6 : TFT+FR H : TFT+D/V BOARD I : TFT+FR+D/V BOARD B : TFT+POWER BD
7	Polarizer Type, Temperature range, View direction	I→Transmissive, W. T, 6:00 ; C→Transmissive, N. T, 6:00 L→Transmissive, W.T,12:00 ; F→Transmissive, N.T,12:00 Y→Transmissive,W.T, IPS TFT ; A→Transmissive, N.T, IPS TFT Z→Transmissive, W.T, O-TFT R→Transmissive, Super W.T, O-TFT N→Transmissive, Super W.T, 6:00; Q→Transmissive, Super W.T, 12:00 V→Transmissive, Super W.T, VA TFT
8	Backlight	W : LED, White H : LED, High Light White F : CCFL, White
9	Driver Method	D: Digital A: Analog L : LVDS M:MIPI
10	Interface	N : without control board A : 8Bit B : 16Bit S:SPI Interface R: RS232 U:USB I: I2C
11	TS	N : Without TS S : resistive touch panel C : capacitive touch panel capacitive touch panel (G-F-F) G : capacitive touch panel(G-G)

2.Summary

TFT 4.3" is a IPS transmissive type color active matrix TFT liquid crystal display that use amorphous silicon TFT as switching devices. This module is a composed of a TFT_LCD module, It is usually designed for industrial application and this module follows RoHs,

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3.General Specifications

- Size: 4.3 inch
- Dot Matrix: 480 x RGBx272(TFT) dots
- Module dimension: 105.5(W) x 67.2(H) x 2.95(D) mm
- Active area: 95.04 x 53.856 mm
- Dot pitch: 0.066 x 0.198 mm
- LCD type: TFT, Normally Black, Transmissive
- Viewing Angle: 80/80/80/80
- Aspect Ratio: 16:9
- TFT Driver IC: SC7283 or equivalent
- Interface: 24-bit RGB
- Backlight Type: LED, Normally White
- With /Without TP: Without TP
- Surface: Glare

*Color tone slight changed by temperature and driving voltage.

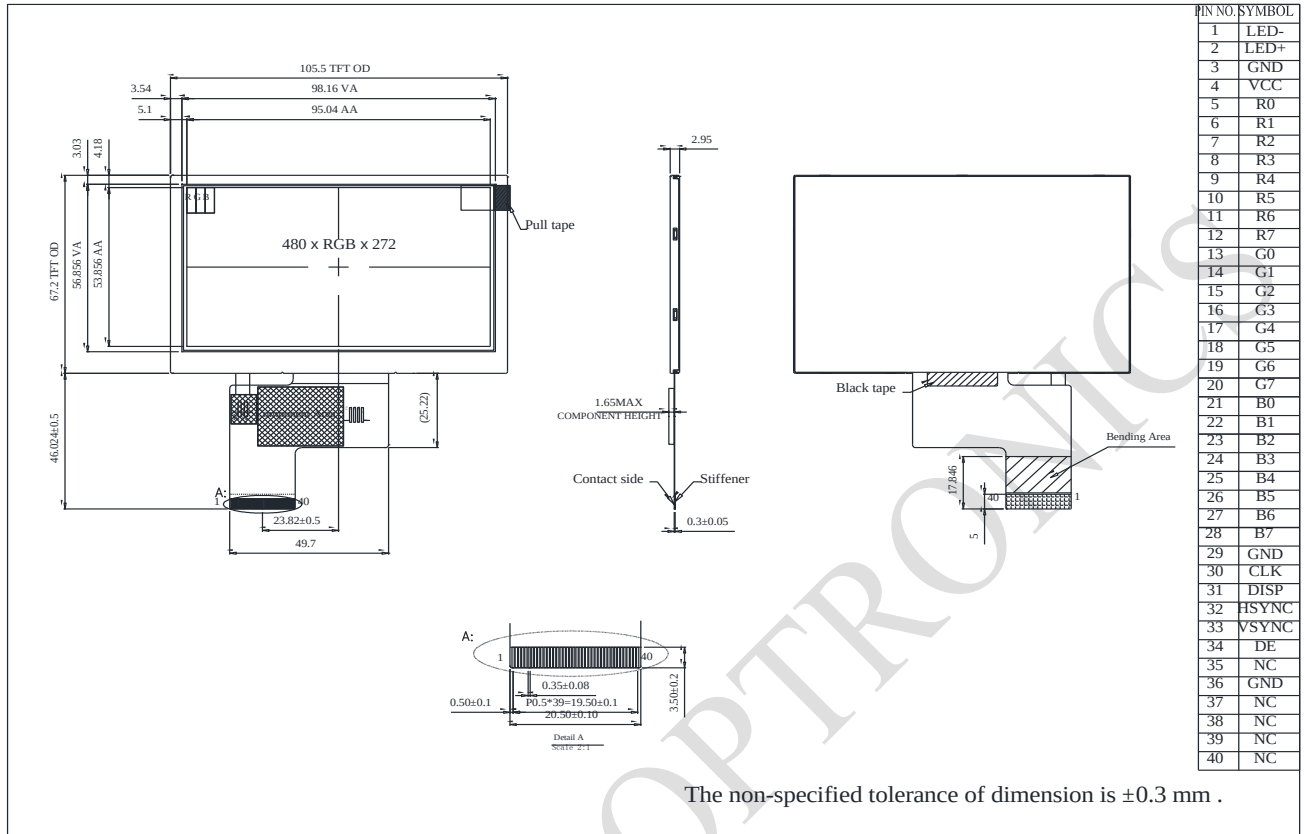
4.Interface

4.1. LCM PIN Definition

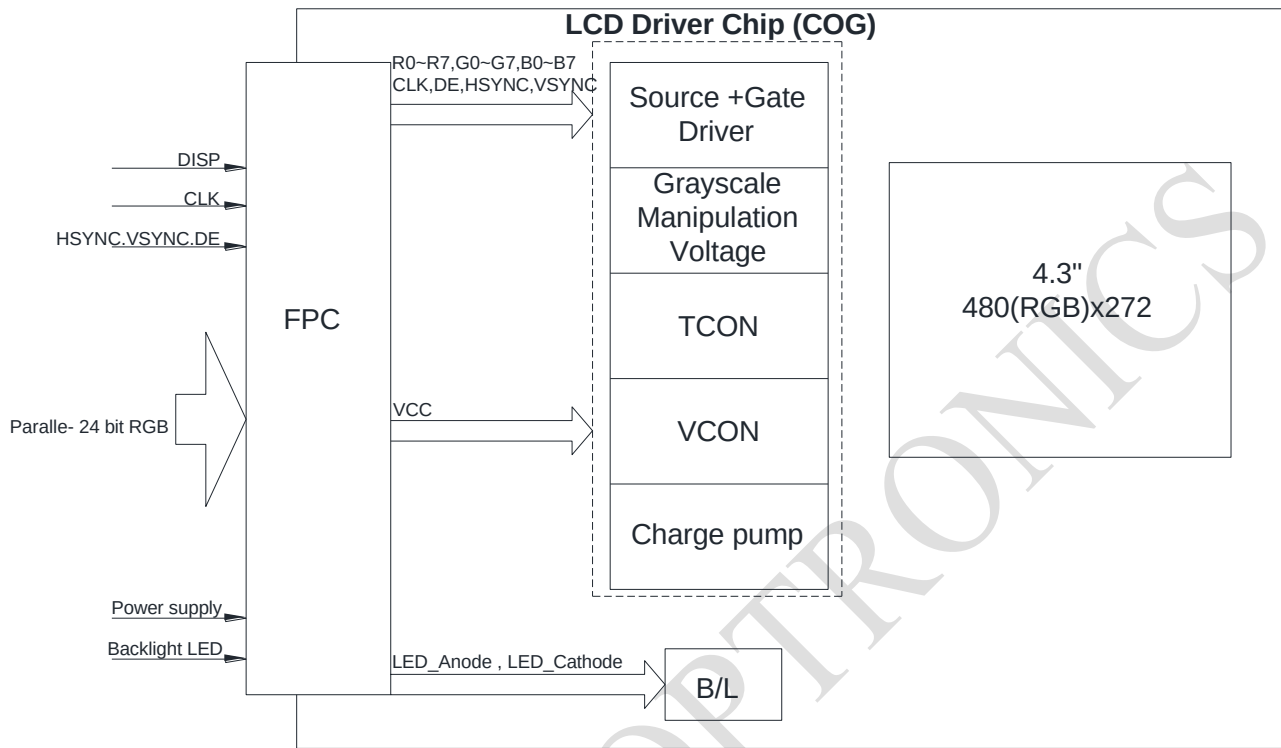
Pin	Symbol	Function	Remark
1	LED-	Power for LED backlight cathode	
2	LED+	Power for LED backlight anode	
3	GND	Power ground	
4	VCC	Power voltage	
5	R0	Red data	
6	R1	Red data	
7	R2	Red data	
8	R3	Red data	
9	R4	Red data	
10	R5	Red data	
11	R6	Red data	
12	R7	Red data	
13	G0	Green data	
14	G1	Green data	
15	G2	Green data	
16	G3	Green data	
17	G4	Green data	
18	G5	Green data	
19	G6	Green data	
20	G7	Green data	
21	B0	Blue data	
22	B1	Blue data	
23	B2	Blue data	
24	B3	Blue data	
25	B4	Blue data	
26	B5	Blue data	
27	B6	Blue data	
28	B7	Blue data	
29	GND	Power ground	

30	CLK	Pixel clock input pin (DCLK)							
31	DISP	DISP sets the display mode. <table><tr><th>DISP</th><th>Function Description</th></tr><tr><td>L</td><td>Standby mode</td></tr><tr><td>H</td><td>Normal display mode</td></tr></table>	DISP	Function Description	L	Standby mode	H	Normal display mode	
DISP	Function Description								
L	Standby mode								
H	Normal display mode								
32	HSYNC	Horizontal sync signal, default is negative polarity.							
33	VSYNC	Vertical sync signal, default is negative polarity.							
34	DE	Data input enable.							
35	NC	No connection							
36	GND	Power ground							
37	NC	No connection							
38	NC	No connection							
39	NC	No connection							
40	NC	No connection							

5. Contour Drawing



6. Block Diagram



7. Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	TOP	-30	—	+80	□
Storage Temperature	TST	-30	—	+80	□

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

- Temp. □60□, 90% RH MAX. Temp. > 60□, Absolute humidity shall be less than 90% RH at 60□

8. Electrical Characteristics

8.1. Operating conditions:

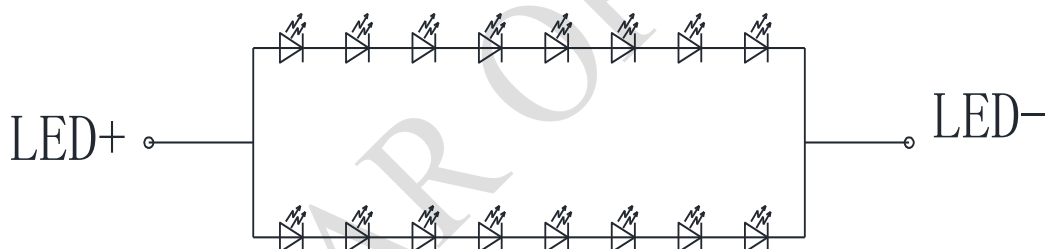
Item	Symbol	Min	Typ	Max	Unit	Remark
Supply Voltage For LCM	VCC	3.0	-	3.6	V	
Supply Current For LCM	ICC	-	25	37.5	mA	Note1

Note 1 : This value is test for VCC=3.3V , Ta=25 °C only

8.2. LED driving conditions

Parameter	Symbol	Min.	Typ.	Max.	Unit	Remark
LED current	-	-	40	-	mA	-
Power Consumption	-	864	1024	1088	mW	-
LED voltage	VLED+	21.6	25.6	27.2	V	Note 1
LED Life Time	-	-	50,000	-	Hr	Note 2,3,4

Note 1 : There are 1 Groups LED



CIRCUIT DIAGRAM(8*2)

Note 2 : Ta = 25 °C

Note 3 : Brightness to be decreased to 50% of the initial value

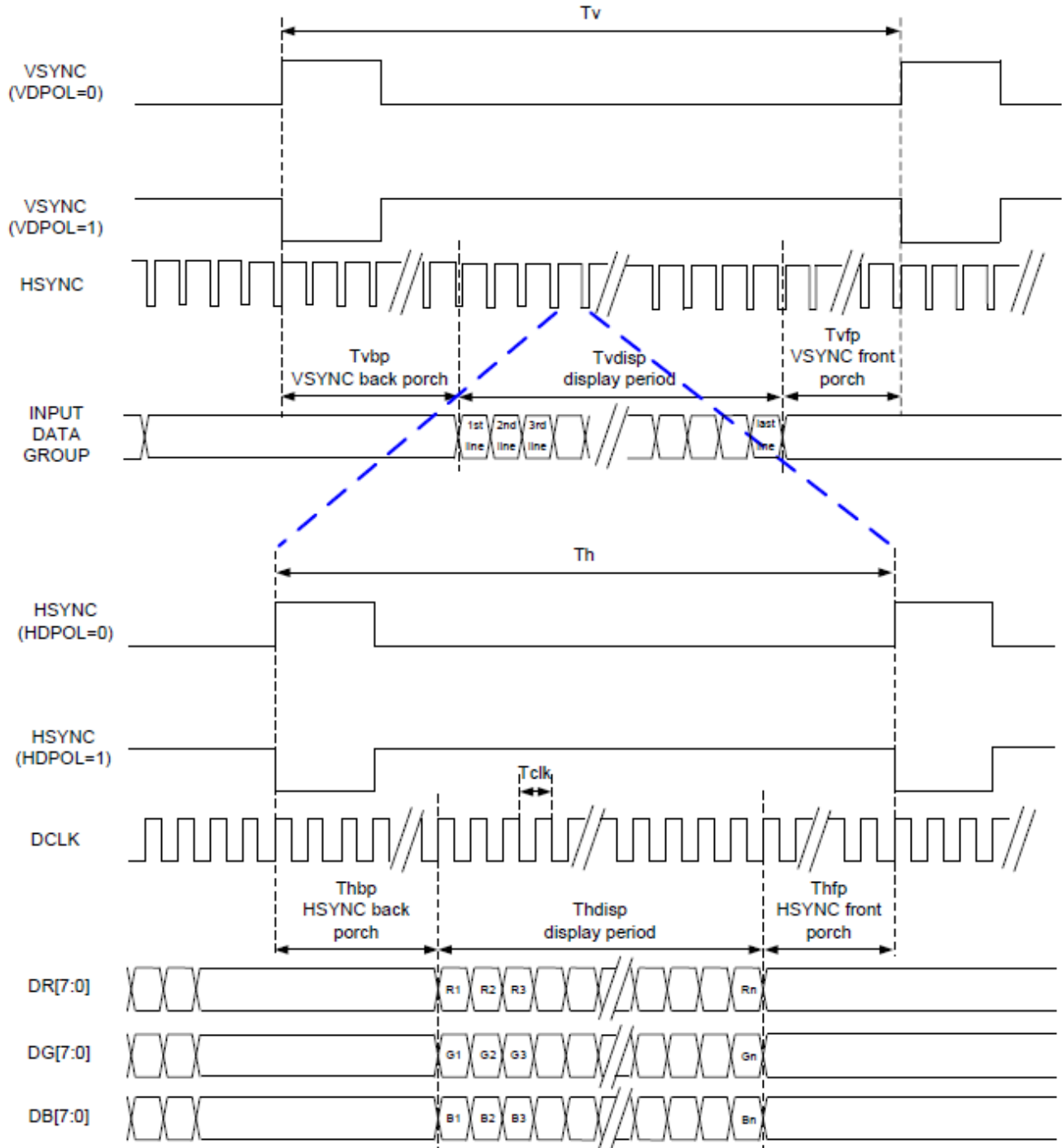
Note 4 : The single LED lamp case

9.AC Characteristics

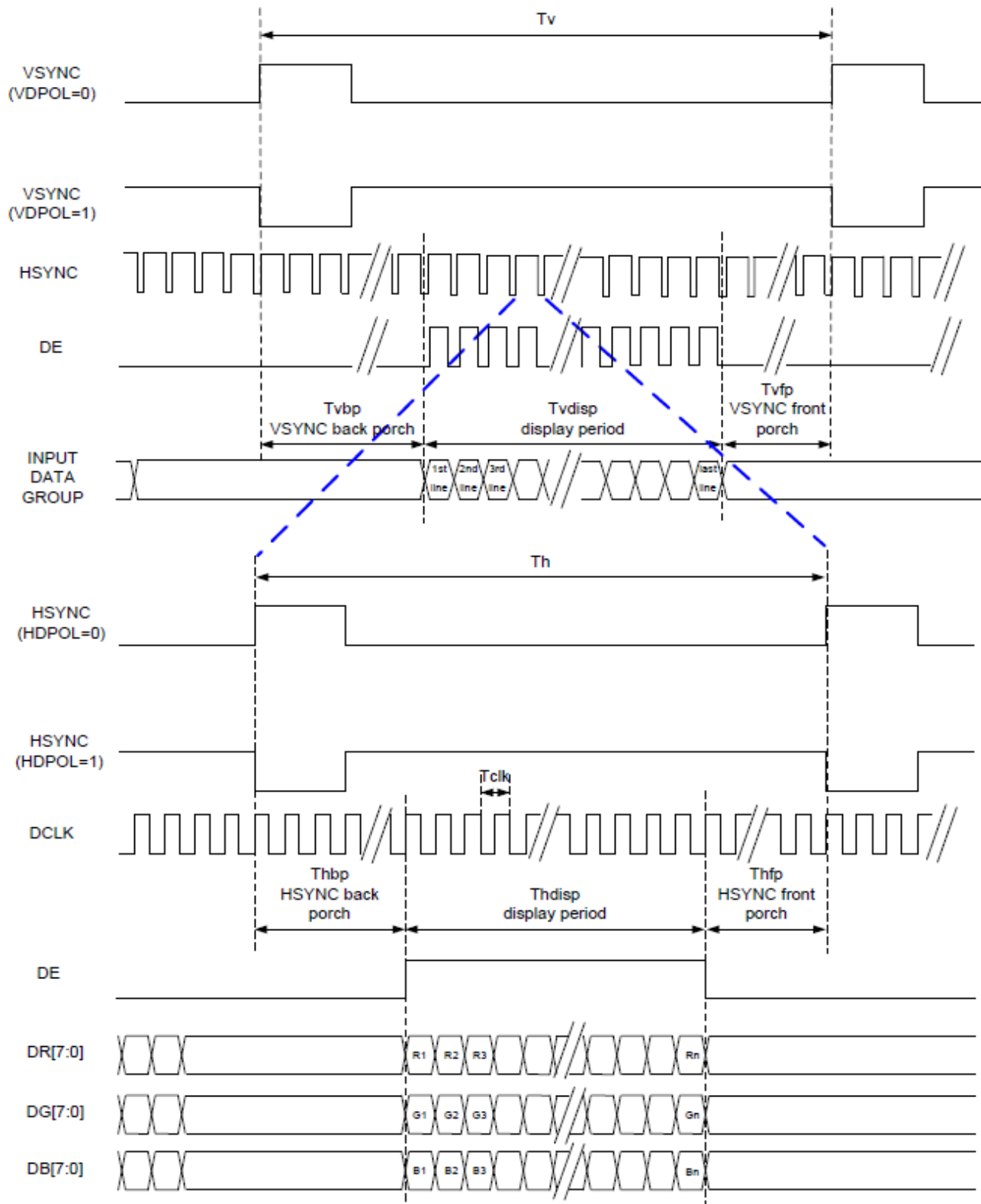
AC Electrical Characteristics (VCC= 3.3V, GND= 0V, TA=25°C)

9.1. RGB Interface

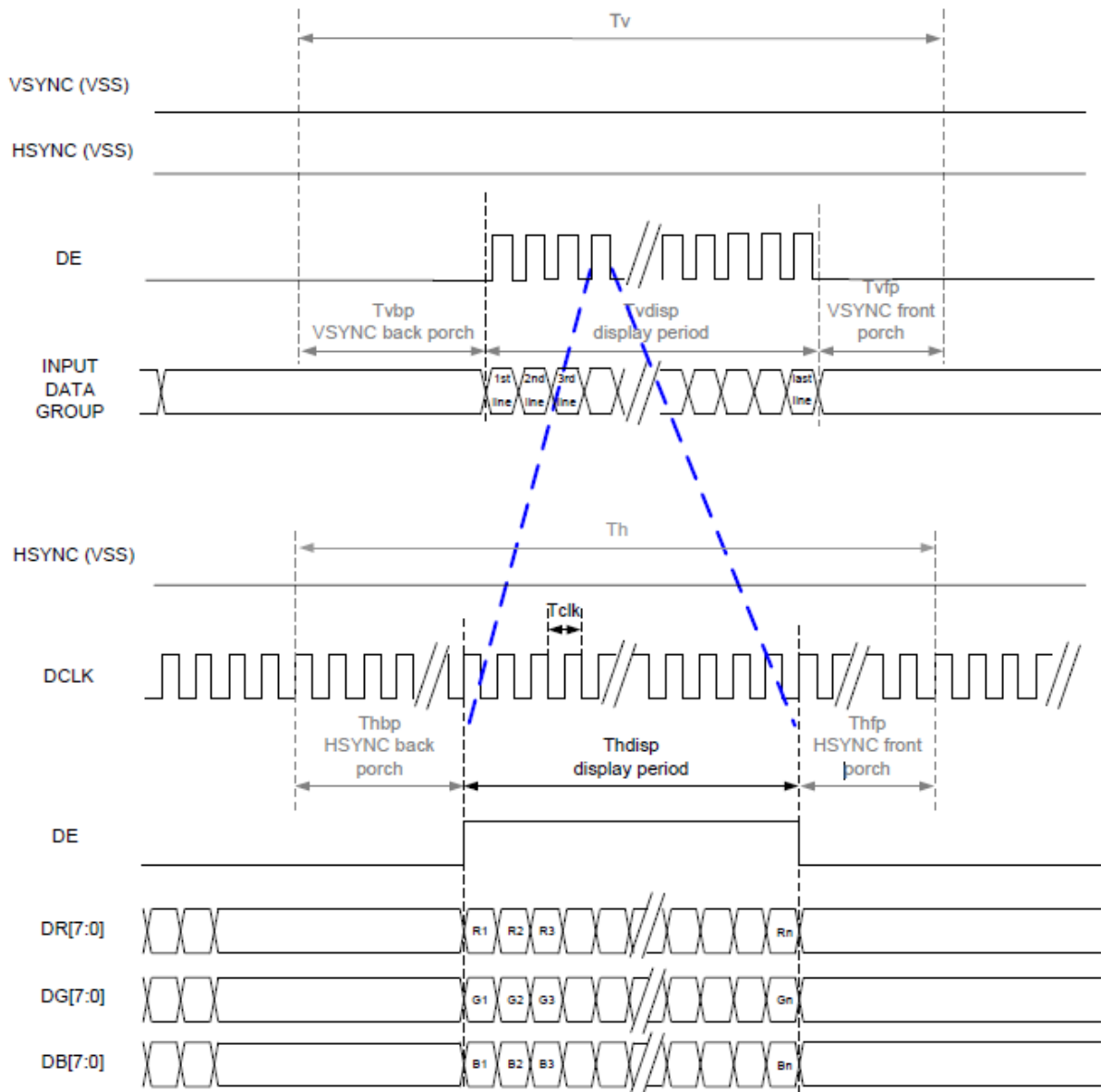
1. SYNC Mode



2. SYNC-DE Mode



3. DE Mode



RGB Mode Selection Table	DCLK	HSYNC	VSYNC	DE
SYNC - DE Mode	Input	Input	Input	Input
SYNC Mode	Input	Input	Input	GND
DE Mode	Input	GND	GND	Input

Note: "Input" means these signals are driven by host side.

9.2. Parallel 24 bit RGB Input Timing Table

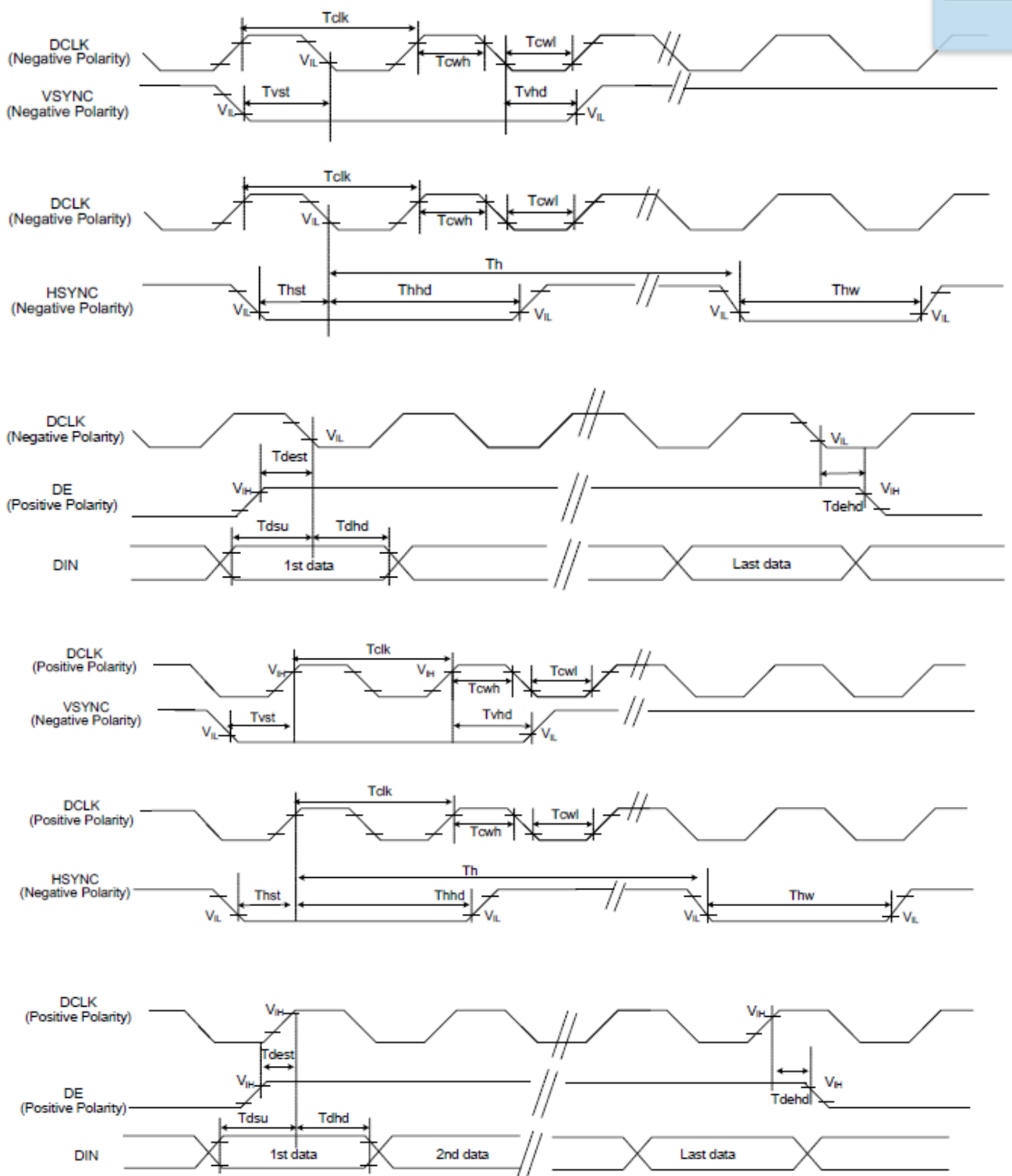
(Parallel 24-bit RGB Input Timing (VCC= 3.3V, GND= 0V, TA=25°C))

480RGB X 272 Resolution Timing Table							
Item		Symbol	Min.	Typ.	Max.	Unit	Remark
DCLK Frequency		Fclk	8	9	12	MHz	
DCLK Period		Tclk	83	111	125	ns	
HSYNC	Period Time	Th	485	531	598	DCLK	
	Display Period	Thdisp		480		DCLK	
	Back Porch	Thbp	3	43	43	DCLK	Thbp of SYNC mode set by H_BLANKING[7:0]
	Front Porch	Thfp	2	8	75	DCLK	
	Pulse Width	Thw	2	4	43	DCLK	
VSYNC	Period Time	Tv	276	292	321	HSYNC	
	Display Period	Tvdisp		272		HSYNC	
	Back Porch	Tvbp	2	12	12	HSYNC	Tvbp of SYNC mode set by V_BLANKING[7:0]
	Front Porch	Tvfp	2	8	37	HSYNC	
	Pulse Width	Tvw	2	4	12	HSYNC	

Note: It is necessary to keep Tvbp =12 and Thbp =43 in sync mode. DE mode is unnecessary to keep it.

9.3. System Bus Timing for RGB Interface

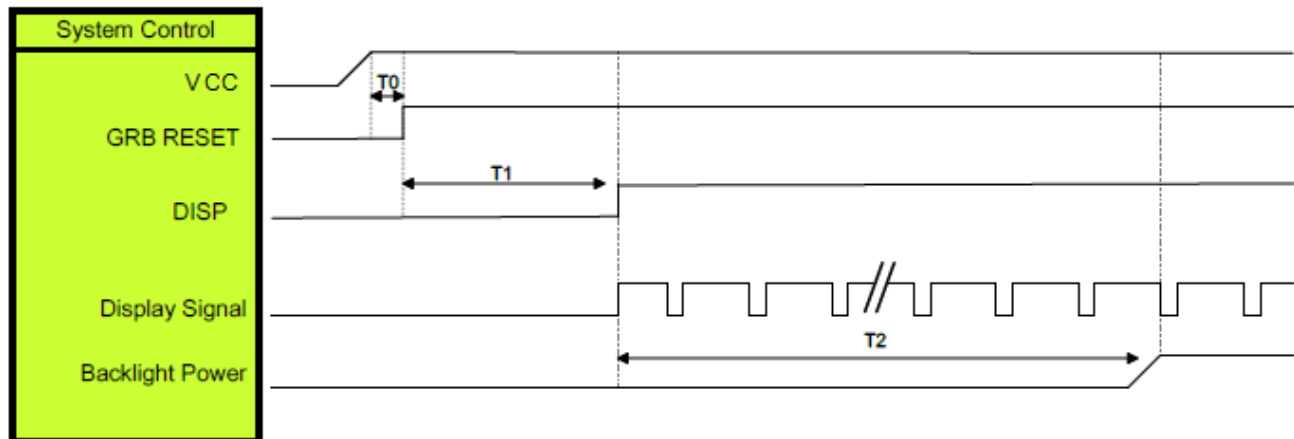
(VCC= 3.3V, GND= 0V, TA=25°C)



Item	Symbol	Min.	Typ.	Max.	Unit	Conditions
CLK Pulse Duty	Tcw	40	50	60	%	
HSYNC Width	Thw	2	-	-	DCLK	
VSYNC Setup Time	Tvst	12	-	-	ns	
VSYNC Hold Time	Tvhd	12	-	-	ns	
HSYNC Setup Time	Thst	12	-	-	ns	
HSYNC Hold Time	Thhd	12	-	-	ns	
Data Setup Time	Tdsu	12	-	-	ns	
Data Hold Time	Tdhd	12	-	-	ns	
DE Setup Time	Tdest	12	-	-	ns	
DE Hold Time	Tdehd	12	-	-	ns	

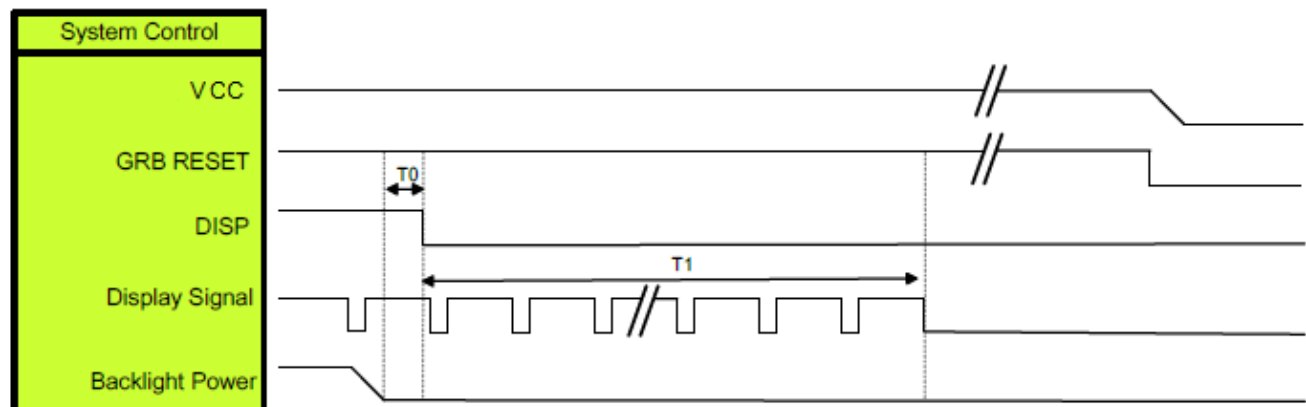
10. Power sequence

10.1. Power On Sequence



Symbol	Description	Min. Time	Unit
T0	System power stability to GRB RESET signal	0	ms
T1	GRB RESET= "High" to DISP="High"	10	ms
T2	Display Signal output to Backlight Power on	250	ms

10.2. Power Off Sequence



Symbol	Description	Min. Time	Unit
T0	Backlight Power off to DISP="Low"	5	ms
T1	DISP="Low" to IC internal voltage discharge complete	80	ms

11.Optical Characteristics

Item		Symbol	Condition.	Min	Typ.	Max.	Unit	Remark
Response time		Tr+ Tf	$\theta=0^{\circ}$ 、 $\Phi=0^{\circ}$	-	30	40	ms	Note 3
Contrast ratio		CR	At optimized viewing angle	640	800	-	-	Note 4
Color Chromaticity	White	Wx	$\theta=0^{\circ}$ 、 $\Phi=0$	0.27	0.32	0.37	-	Note 2,6,7
		Wy		0.295	0.345	0.395	-	
Viewing angle	Hor.	ΘR	$CR \geq 10$	70	80	-	Deg.	Note 1
		ΘL		70	80	-		
	Ver.	ΦT		70	80	-		
		ΦB		70	80	-		
Brightness		-	-	850	1000	-	cd/m ²	Center of display
Uniformity		(U)	-	75	-	-	%	Note 5

Ta=25±2℃, IL=40mA

Note 1: Definition of viewing angle range

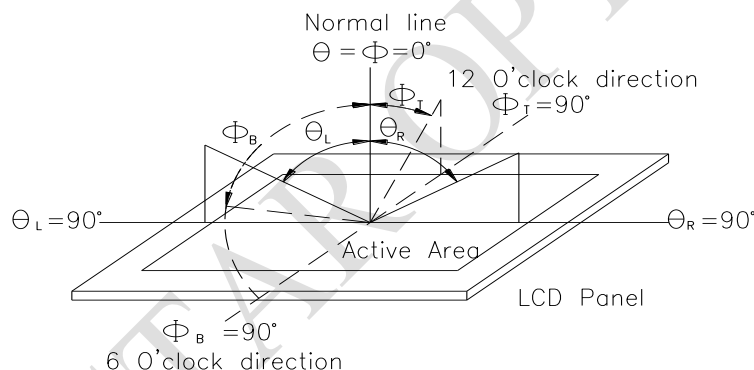


Fig. 11.1. Definition of viewing angle

Note 2: Test equipment setup:

After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7orBM-5 luminance meter 1.0° field of view at a distance of 50cm and normal direction.

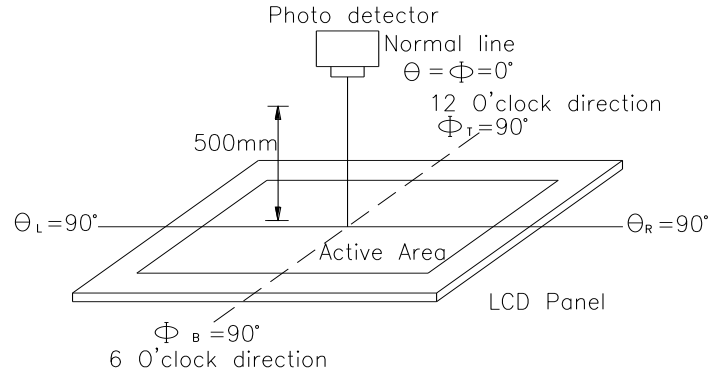
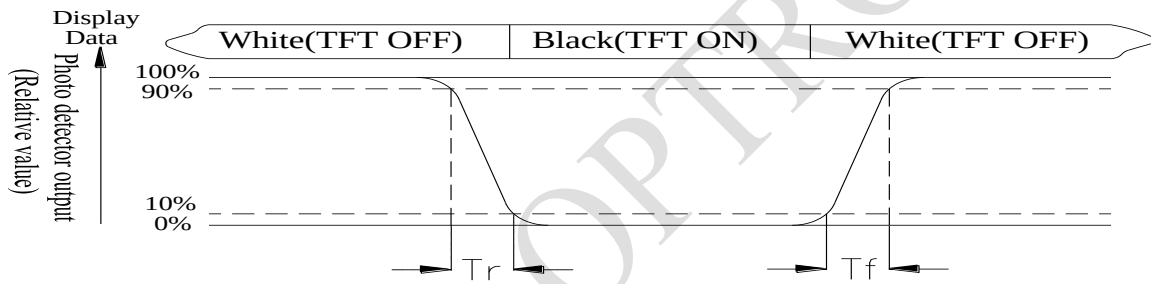


Fig. 11.2. Optical measurement system setup

Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time, T_r , is the time between photo detector output intensity changed from 90% to 10%. And fall time, T_f , is the time between photo detector output intensity changed from 10% to 90%



Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

$$\text{Contrast ratio (CR)} = \frac{\text{Luminance measured when LCD on the "White" state}}{\text{Luminance measured when LCD on the "Black" state}}$$

Note 5: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (reference the picture in below). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (U) = $L_{min}/L_{max} \times 100\%$

L = Active area length

W = Active area width



Fig 11.3. Definition of uniformity

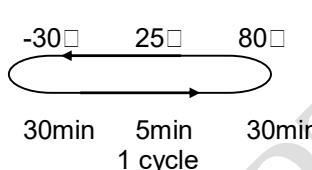
Note 6: Definition of color chromaticity (CIE 1931)

Color coordinates measured at the center point of LCD

Note 7: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

12. Reliability

Content of Reliability Test (Super Wide temperature, -30℃~80℃)

Environmental Test			
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80℃ 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30℃ 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80℃ 200hrs	—
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-30℃ 200hrs	1
High Temperature/Humidity storage	The module should be allowed to stand at 60℃,90%RH max	60℃,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation 	-30℃/80℃ 10 cycles	—
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact) ,±800v(air), RS=330Ω CS=150pF 10 times	—

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

LCM Sample Estimate Feedback Sheet

Module Number : _____

1 、 Panel Specification :

1. Panel Type :	☐ Pass	☐ NG , _____
2. View Direction :	☐ Pass	☐ NG , _____
3. Numbers of Dots :	☐ Pass	☐ NG , _____
4. View Area :	☐ Pass	☐ NG , _____
5. Active Area :	☐ Pass	☐ NG , _____
6. Operating Temperature :	☐ Pass	☐ NG , _____
7. Storage Temperature :	☐ Pass	☐ NG , _____
8. Others : _____		

2 、 Mechanical Specification :

1. PCB Size :	☐ Pass	☐ NG , _____
2. Frame Size :	☐ Pass	☐ NG , _____
3. Material of Frame :	☐ Pass	☐ NG , _____
4. Connector Position :	☐ Pass	☐ NG , _____
5. Fix Hole Position :	☐ Pass	☐ NG , _____
6. Backlight Position :	☐ Pass	☐ NG , _____
7. Thickness of PCB :	☐ Pass	☐ NG , _____
8. Height of Frame to PCB :	☐ Pass	☐ NG , _____
9. Height of Module :	☐ Pass	☐ NG , _____
10. Others :	☐ Pass	☐ NG , _____

3 、 Relative Hole Size :

1. Pitch of Connector :	☐ Pass	☐ NG , _____
2. Hole size of Connector :	☐ Pass	☐ NG , _____
3. Mounting Hole size :	☐ Pass	☐ NG , _____
4. Mounting Hole Type :	☐ Pass	☐ NG , _____
5. Others :	☐ Pass	☐ NG , _____

4 、 Backlight Specification :

1. B/L Type :	☐ Pass	☐ NG , _____
2. B/L Color :	☐ Pass	☐ NG , _____
3. B/L Driving Voltage (Reference for LED Type) : ☐ Pass ☐ NG , _____		
4. B/L Driving Current :	☐ Pass	☐ NG , _____
5. Brightness of B/L :	☐ Pass	☐ NG , _____
6. B/L Solder Method :	☐ Pass	☐ NG , _____
7. Others :	☐ Pass	☐ NG , _____

>> **Go to page 2** <<

Module Number : _____

5 、 Electronic Characteristics of Module :

1.Input Voltage :	☐ Pass	☐ NG , _____
2.Supply Current :	☐ Pass	☐ NG , _____
3.Driving Voltage for LCD :	☐ Pass	☐ NG , _____
4.Contrast for LCD :	☐ Pass	☐ NG , _____
5.B/L Driving Method :	☐ Pass	☐ NG , _____
6.Negative Voltage Output :	☐ Pass	☐ NG , _____
7.Interface Function :	☐ Pass	☐ NG , _____
8.LCD Uniformity :	☐ Pass	☐ NG , _____
9.ESD test :	☐ Pass	☐ NG , _____
10.Others :	☐ Pass	☐ NG , _____

6 、 Summary :
Sales signature : _____

Customer Signature : _____

Date : / /